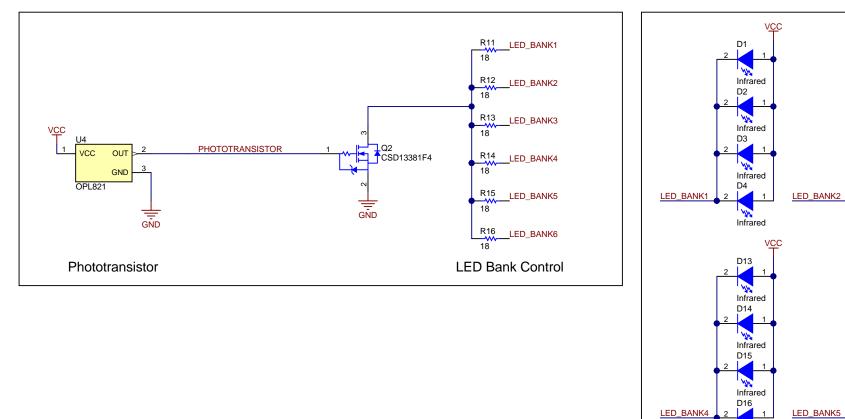


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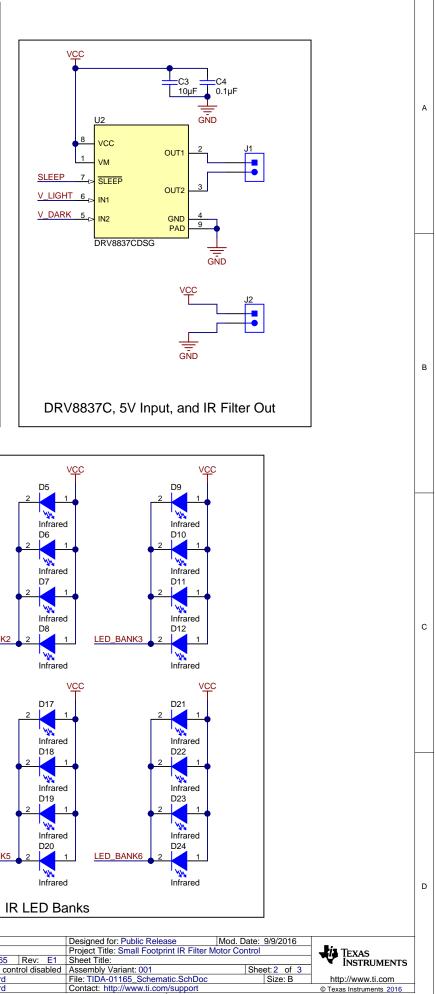
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m functionality for your application.	Engineer: Phil Beard	

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X FID1 FID3 FID2 FID5 FID4 FID6 PCB LOGO Pb-Free Symbol PCB LOGO

Texas Instruments

PCB Number: TIDA-01165 PCB Rev: E1

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ZZ1 Assembly Note These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 Assembly Note These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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	Engineer:	Phil Beard	
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	Project Title: Small Footprint IR Filter Motor Control			JI TEXAS
ev: E1	Sheet Title:			TEXAS INSTRUMENTS
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	File: TIDA_01165_Hardware.SchDoc		Size: B	http://www.ti.com
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